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PATENT / DOCKET NO. 22397.266
CUSTOMER NO. 27683

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Chan, et al.

Serial No.: 10/035,387

Filed: December 28, 2001

For: SURFACE DISTORTION
COMPENSATED PHOTOLITHOGRAPHY

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Group Art Unit: 2873

Examiner: Unknown

Commissioner For Patents
Washington, DC 20231

Sir:

Pursuant to the provisions of 37 C.F.R. § 1.97, Applicant hereby makes of record the references set forth in the attached modified form PTO-1449. No inference should be made that the cited references are in fact material, are in fact prior art, or that no better art exists. The cited patents are listed in numerical order and not in any order based on their pertinence.

Pursuant to 37 C.F.R. § 1.98(d), no copies of the cited references are enclosed since the references were provided in the parent application, U.S. Serial No. 09/918,732 and in Serial No. 09/728,691 and Serial No. 09/718,619. However, Cite Numbers A19, A20, A21 and A23 have not been disclosed in this application or any related application, therefore copies of those patents are enclosed herewith.

It is requested that the Examiner fully consider the cited references and that they be cited on the front of any patent issuing from this application.

An early action on the merits is respectfully requested.

Respectfully submitted,

David M. O'Dell
Reg. No. 42,044

Dated: 3-8-02

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner For Patents, Washington, D.C. 20231	
on	March 11, 2002
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In place of PTO-1449 Form	U. S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE MAY 20 2002 INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>			Complete if Known	
SHEET	1	OF	2	Application Number	10/035,387
				Filing Date	12/28/2001
				Applicant(s)	Kin Foong Chan et al.
				Art Unit	
				Examiner Name	Unknown
				Attorney Docket Number	22397.266

U. S. PATENT DOCUMENTS				
Examiner's Initials	Cite No.	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
	A1	3,534,467	10/20/70	B. Sachs et al.
	A2	4,126,812	11/21/78	Wakefield
	A3	4,774,047	05/10/88	Okamoto et al.
	A4	4,879,466	11/07/89	Kitaguchi et al.
	A5	5,049,901	09/17/91	Gelbart
	A6	5,079,544	01/07/92	DeMond et al.
	A7	5,106,455	04/21/92	Jacobsen et al.
	A8	5,109,290	04/28/92	Imai
	A9	5,121,983	06/16/92	Lee
	A10	5,131,976	07/21/92	Hoko
	A11	5,132,723	07/21/92	Gelbart
	A12	5,208,818	05/04/93	Gelbart et al.
	A13	5,212,588	05/18/93	Viswanathan et al.
	A14	5,269,882	12/14/93	Jacobsen
	A15	5,281,996	01/25/94	Bruning et al.
	A16	5,300,966	04/05/94	Uehira et al.
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	A19	5,444,566	08/22/95	Gale et al.
	A20	5,640,479	6/17/97	Hegg et al.
	A21	5,650,881	7/22/97	Horbeck
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	A23	5,771,116	6/23/98	Miller et al.
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	A43	6,014,203	01/11/00	Ohkawa
	A44	6,031,598	02/29/00	Tichenor et al.
	A45	6,033,079	03/07/00	Hudyma
	A46	6,048,011	04/11/00	Fruhling et al
	A47	6,052,517	04/18/00	Matsunga et al
	A48	6,061,118	05/09/00	Takeda

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	A49	6,071,315	06/06/00	Ramamurthi et al.
	A50	6,072,518	06/06/00	Gelbart
	A51	6,084,656	07/04/00	Choi et al.
	A52	6,107,011	08/22/00	Gelbart
	A53	6,110,607	08/29/00	Montcalm et al.
	A54	6,124,876	09/26/00	Sunagawa
	A55	6,133,986	10/17/00	Johnson
	A56	6,133,986	10/17/00	Johnson
	A57	6,142,641	11/07/00	Cohen et al.
	A58	6,205,364	03/20/01	Lichtenstein et al.
	A59	6,251,550	06/26/01	Ishikawa

FOREIGN PATENT DOCUMENTS

Examiner's Initials	Cite No.	Foreign Patent Document (Country Code - Number - Kind)	Publication Date MM-DD-YYYY	Patentee or Applicant of Cited Document	Translation YN
	B1	PCT 9110170	11/07/91		
	B2	EP 0552953	28/07/93		

OTHER PRIOR ART

Examiner's Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article, title of the item, date, page(s), volume-issue number(s), publisher, city/country where published
	C1	Dr. John R. Carruthers and Dr. James A. Glaze/TWO EXPERTS ON THE FRONTIERS OF LITHOGRAPHY/Insights & Enterprise/June, 2000/pages 82-83.
	C2	"New Multi-EB Direct Write Concept for Maskless High Throughput", Canon SubMicron Focus, Volume 5, Summer 2000
	C3	Sandstrom and Odselius, "Large-Area High Quality Photomasks", Micronic Laser Systems, published by SPIE, Volume 2621, 1985, pgs. 312-318
	C4	Singh-Gasson, Sangeet et al., "Maskless Fabrication of Light-Directed Oligonucleotide Microarrays Using a Digital Micromirror Array, Volume 17, No. 10, October 1999, pgs. 974-978
	C5	Devitt, Terry, "Advanced May Put Gene Chip Technology on Scientists Desktops", http://www.biotech.wise.edu/Education/biotechnews/GeneChip.html , October 7, 1999

Examiner Signature	Date Considered
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.

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